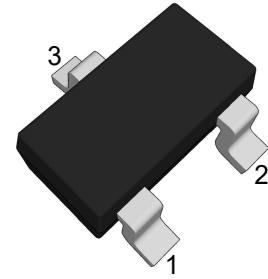


**P-Channel Enhancement Mode Power MOSFET  
SOT-23-3**
**Product Summary**

- $V_{DS} = -30V, I_D = -4.4A$
- $R_{DS(on)} < 60m\Omega @ V_{GS} = -10V$
- $R_{DS(on)} < 78m\Omega @ V_{GS} = -4.5V$
- $R_{DS(on)} < 78m\Omega @ V_{GS} = -2.5V$

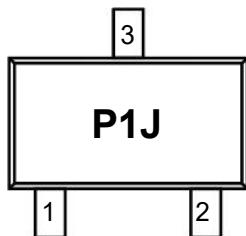
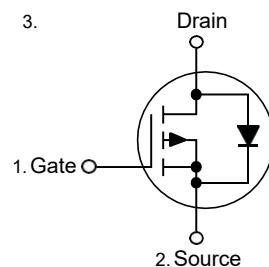

**(Top View)**
**Features**

- Advanced Trench Technology
- RoHS and Reach Compliant
- Halogen and Antimony Free
- Moisture Sensitivity Level 3

**Application**

- Load Switch
- PWM Application

Pin	Description
1	Gate
2	Source
3	Drain

**Marking Code**

**Schematic Diagram**

**Absolute Maximum Ratings**

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	- $V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Drain Current-Continuous	- $I_D$	4.4	A
Drain Current-Pulsed <sup>Note1</sup>	- $I_{DM}$	20	A
Maximum Power Dissipation	$P_D$	1.25	W
Junction Temperature	$T_J$	150	°C
Storage Temperature Range	$T_{STG}$	-55 to +150	°C

**Thermal Characteristics**

Thermal Resistance, Junction-to-Ambient <sup>Note2</sup>	$R_{\theta JA}$	100	°C/W
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## Electrical Characteristics

(Ta=25°C unless otherwise specified)

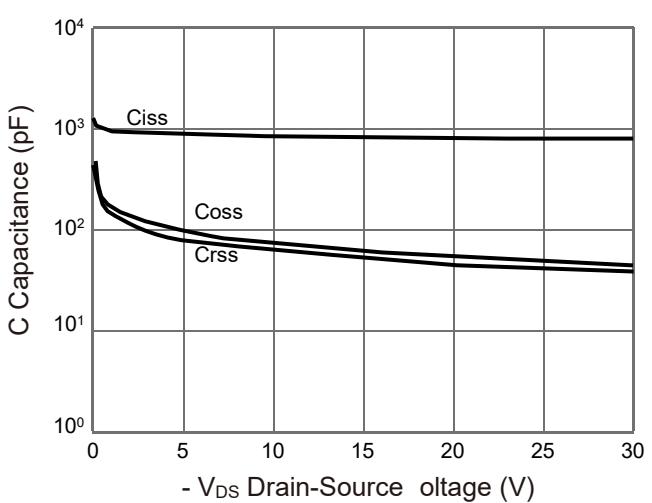
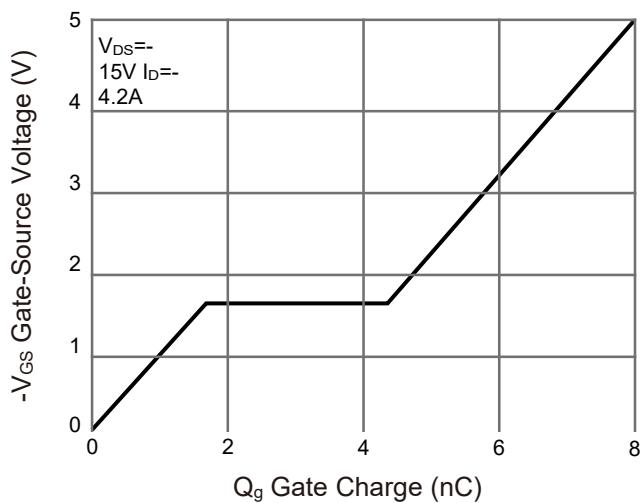
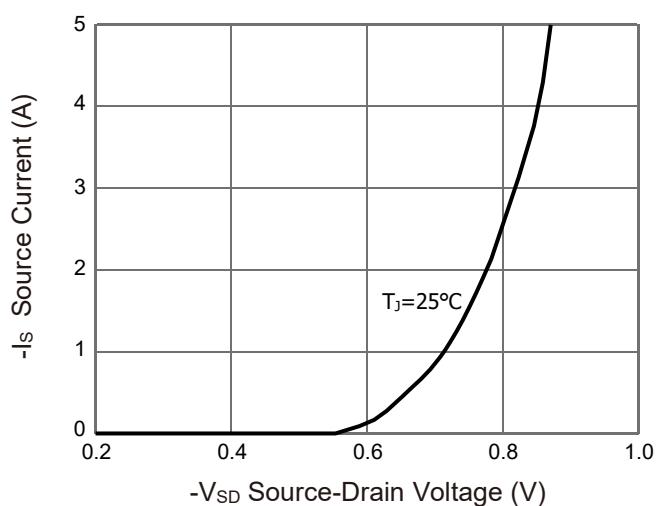
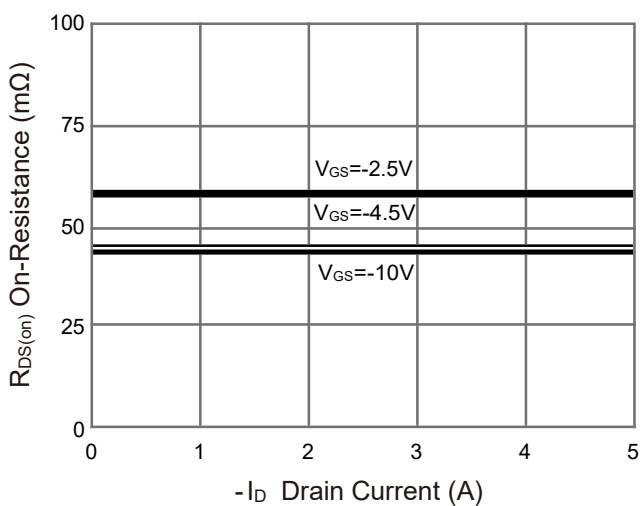
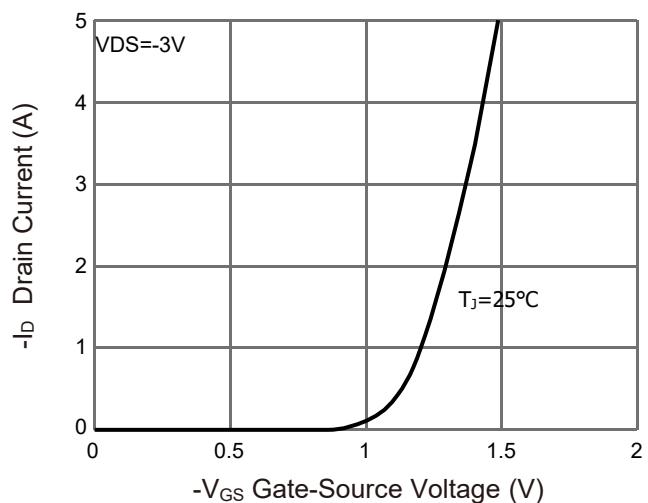
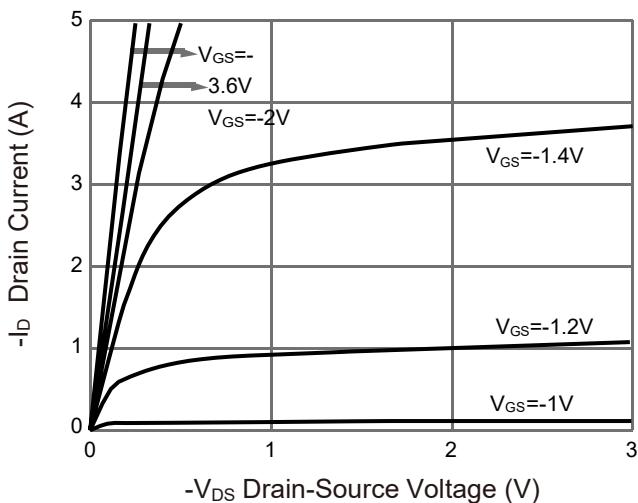
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	-V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA	30	--	--	V
Zero Gate Voltage Drain Current	-I <sub>DSS</sub>	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V	--	--	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V	--	--	±100	nA
Gate Threshold Voltage <sup>Note3</sup>	-V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	0.5	0.8	1.4	V
Drain-Source On-Resistance <sup>Note3</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-4.4A	--	41	50	mΩ
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-4A	--	45	65	mΩ
		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-1A	--	55	90	mΩ
Forward Transconductance <sup>Note3</sup>	g <sub>FS</sub>	V <sub>DS</sub> =-5V, I <sub>D</sub> =-2A	--	9.5	--	S
<b>Dynamic Characteristics</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1MHz	--	780	--	pF
Output Capacitance	C <sub>oss</sub>		--	65	--	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		--	52	--	pF
Gate Resistance	R <sub>g</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz	--	13	--	Ω
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-15V, I <sub>D</sub> = -4.2A, V <sub>GS</sub> =0~ -4.5V	--	8	--	nC
Gate-Source Charge	Q <sub>gs</sub>		--	1.8	--	nC
Gate-Drain Charge	Q <sub>gd</sub>		--	2.7	--	nC
<b>Switching Characteristics</b>						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =-15V, I <sub>D</sub> =-4.2A, V <sub>GS</sub> =-10V, R <sub>GEN</sub> =3Ω	--	7	--	nS
Turn-on Rise Time	t <sub>r</sub>		--	3	--	nS
Turn-off Delay Time	t <sub>d(off)</sub>		--	30	--	nS
Turn-off Fall Time	t <sub>f</sub>		--	12	--	nS
<b>Source-Drain Diode Characteristics</b>						
Diode Forward Voltage <sup>Note3</sup>	-V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>s</sub> =-4.4A	--	--	1.2	V
Diode Forward Current <sup>Note2</sup>	-I <sub>s</sub>		--	--	4.4	A

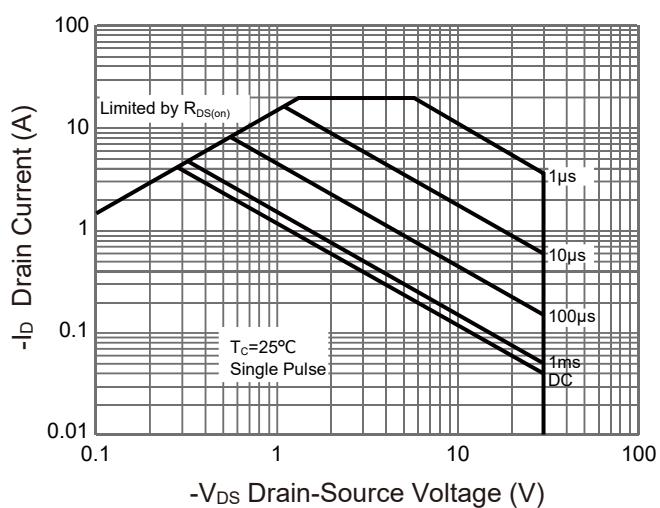
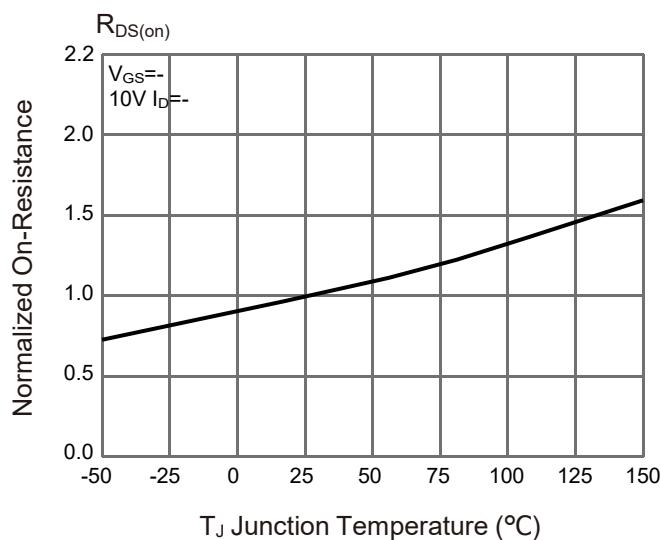
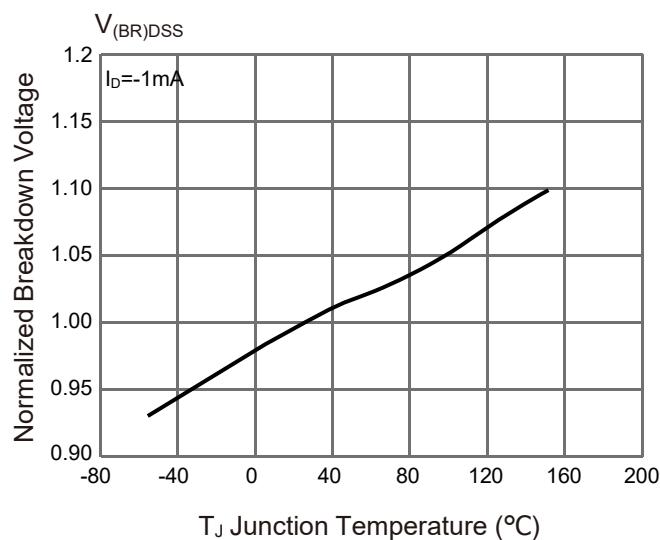
Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t ≤ 10 sec.

3. Pulse Test: Pulse width≤300μs, duty cycle≤2%.

### Typical Characteristic Curves

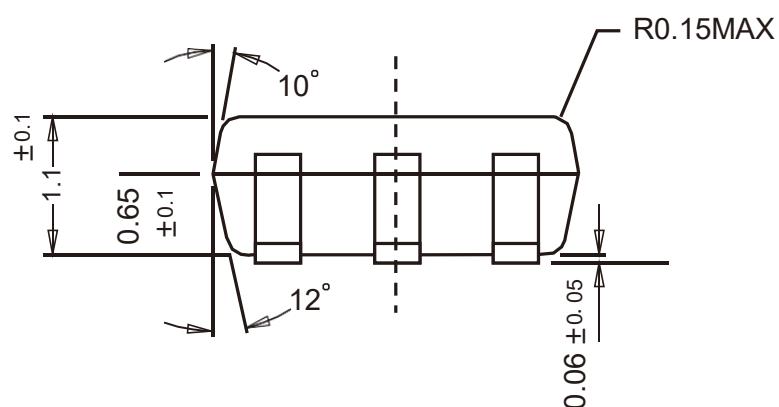
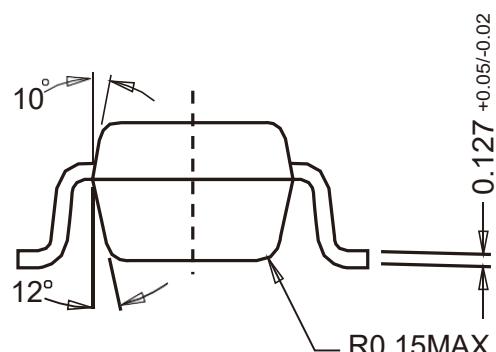
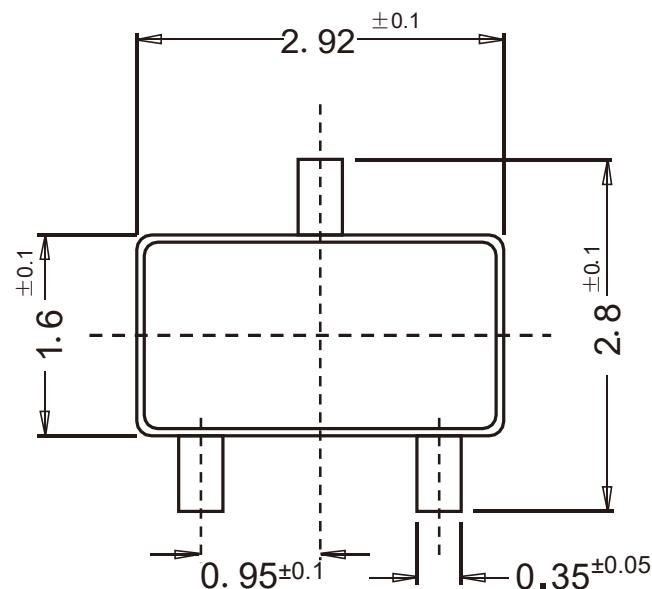




## Package Outline

SOT-23-3

Dimensions in mm

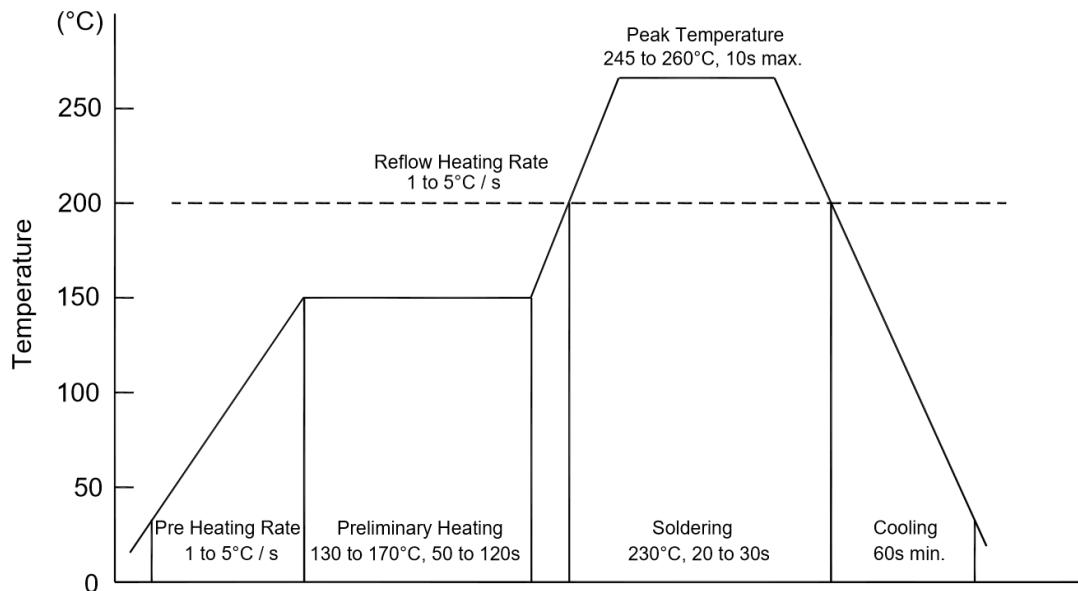


## Ordering Information

Device	Package	Shipping
TN3401PSC	SOT-23-3	3,000PCS/Reel&7inches

## Conditions of Soldering and Storage

### ◆ Recommended condition of reflow soldering



Recommended peak temperature is over 245°C. If peak temperature is below 245°C, you may adjust the following parameters:

- Time length of peak temperature (longer)
- Time length of soldering (longer)
- Thickness of solder paste (thicker)

### ◆ Conditions of hand soldering

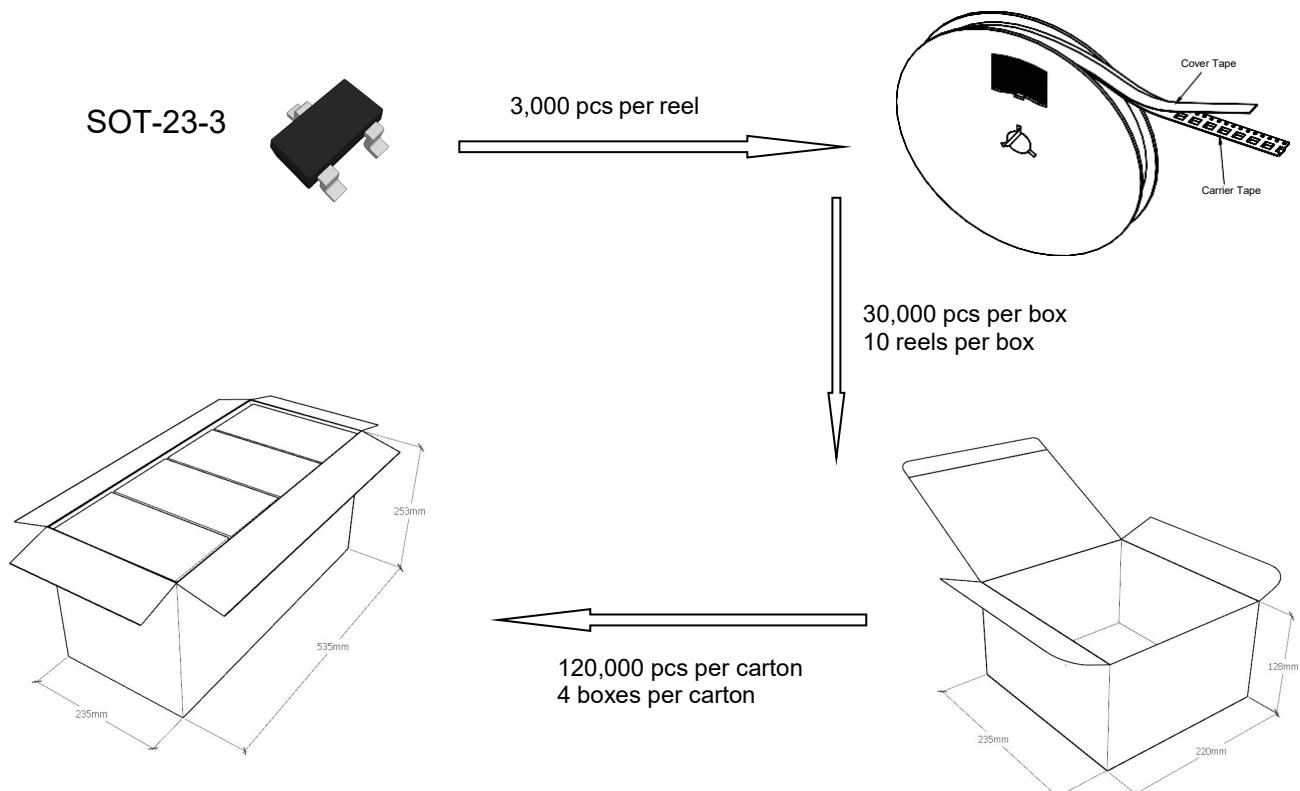
- Temperature: 300°C
- Time: 3s max.
- Times: one time

### ◆ Storage conditions

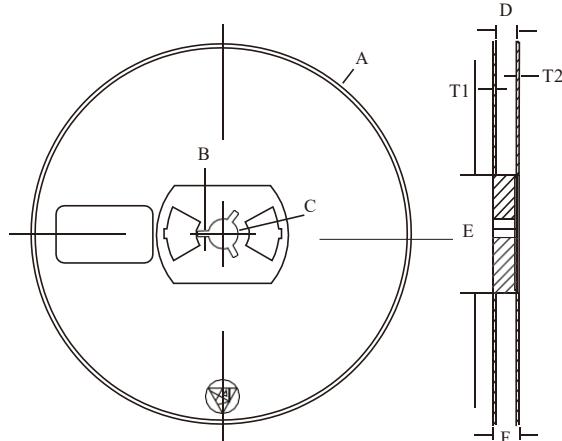
- **Temperature**  
5 to 40°C
- **Humidity**  
30 to 80% RH
- **Recommended period**  
One year after manufacturing

## Package Specifications

- The method of packaging



### ◆ Embossed tape and reel data



Symbol	Value (unit: mm)
A	$\varnothing 177.8 \pm 1$
B	$2.7 \pm 0.2$
C	$\varnothing 13.5 \pm 0.2$
E	$\varnothing 54.5 \pm 0.2$
F	$12.3 \pm 0.3$
D	$9.6 +2/-0.3$
T1	$1.0 \pm 0.2$
T2	$1.2 \pm 0.2$

**Reel (7")**

